Infineon Technologies - MB90F543GSPF-GS-9012 Datasheet

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, EBI/EMI, SCI, Serial I/O, UART/USART
Peripherals	POR, WDT
Number of I/O	81
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90f543gspf-gs-9012

Starting by an external trigger input.
Conversion time : 26.3 μs

- FULL-CAN interfaces
  MB90540G series : 2 channels
  MB90545G series : 1 channel
  Conforming to Version 2.0 Part A and Part B
  Flexible message buffering (mailbox and FIFO buffering can be mixed)
- External bus interface : Maximum address space 16 Mbytes
- Package: QFP-100, LQFP-100

Contents

1. Product Lineup

Features	MB90F543G (S) /F548G (S) MB90F549G (S) /F546G (S) MB90F548GL(S)	MB90543G (S) MB90547G (S) MB90548G (S) MB90549G (S)	MB90V540G
CPU	F²MC-16LX CPU		
System clock	On-chip PLL clock multiplier (×1, ×2, ×3, ×4, 1/2 when PLL stop) Minimum instruction exection time : 62.5 ns (machine clock 16MHz, 4MHz osc. four times multiplied by PLL)		
ROM	Flash memory MB90F543G(S)/F548G(S) / F548GL(S) : 128 Kbytes MB90F549G(S)/F546G(S) : 256 Kbytes	MASK ROM : MB90547G(S): 64 Kbytes MB90543G(S)/548G(S): 128 Kbytes MB90549G(S): 256 Kbytes	External
RAM	MB90F548G(S)/F548GL(S): 4 Kbytes MB90F543G (S) /F549G(S) : 6 Kbytes MB90F546G(S) : 8 Kbytes	MB90547G(S): 2 Kbytes MB90548G(S): 4 Kbytes MB90543G(S)/549G(S): 6 Kbytes	8 Kbytes
Clocks	MB90F543G/F548G/F549G/F546G/F548GL : Two clocks system MB90F543GS/F548GS/F549GS/F546GS/F548GLS : One clock system	MB90543G/547G/548G/549G : Two clocks system MB90543GS/547GS/548GS/549GS : One clock system	Two clocks system*1
Operating voltage range	*3		
Temperature range	−40 °C to 105 °C		
Package	QFP100, LQFP100		PGA-256
Emulator-specify power supply*2	—		None
UART0	Full duplex double buffer Support asynchronous/synchronous (with start/stop bit) transfer Baud rate : 4808/5208/9615/10417/19230/38460/62500/500000 bps (asynchronous) 500 K/1 M/2 Mbps (synchronous) at System clock = 16 MHz		
UART1 (SCI)	Full duplex double buffer Asynchronous (start-stop synchronized) and CLK-synchronous communication Baud rate : 1202/2404/4808/9615/19230/31250/38460/62500 bps (asynchronous) 62.5 K/125 K/250 K/500 K/1 M/2 Mbps (synchronous) at 6, 8, 10, 12, 16 MHz		
Serial I/O	Transfer can be started from MSB or LSB Supports internal clock synchronized transfer and external clock synchronized transfer Supports positive-edge and nagative-edge clock synchronization Baud rate : 31.25 K/62.5 K/125 K/500 K/1 Mbps at System clock = 16 MHz		
A/D Converter	10-bit or 8-bit resolution 8 input channels Conversion time : 26.3 µs (per one channel)		

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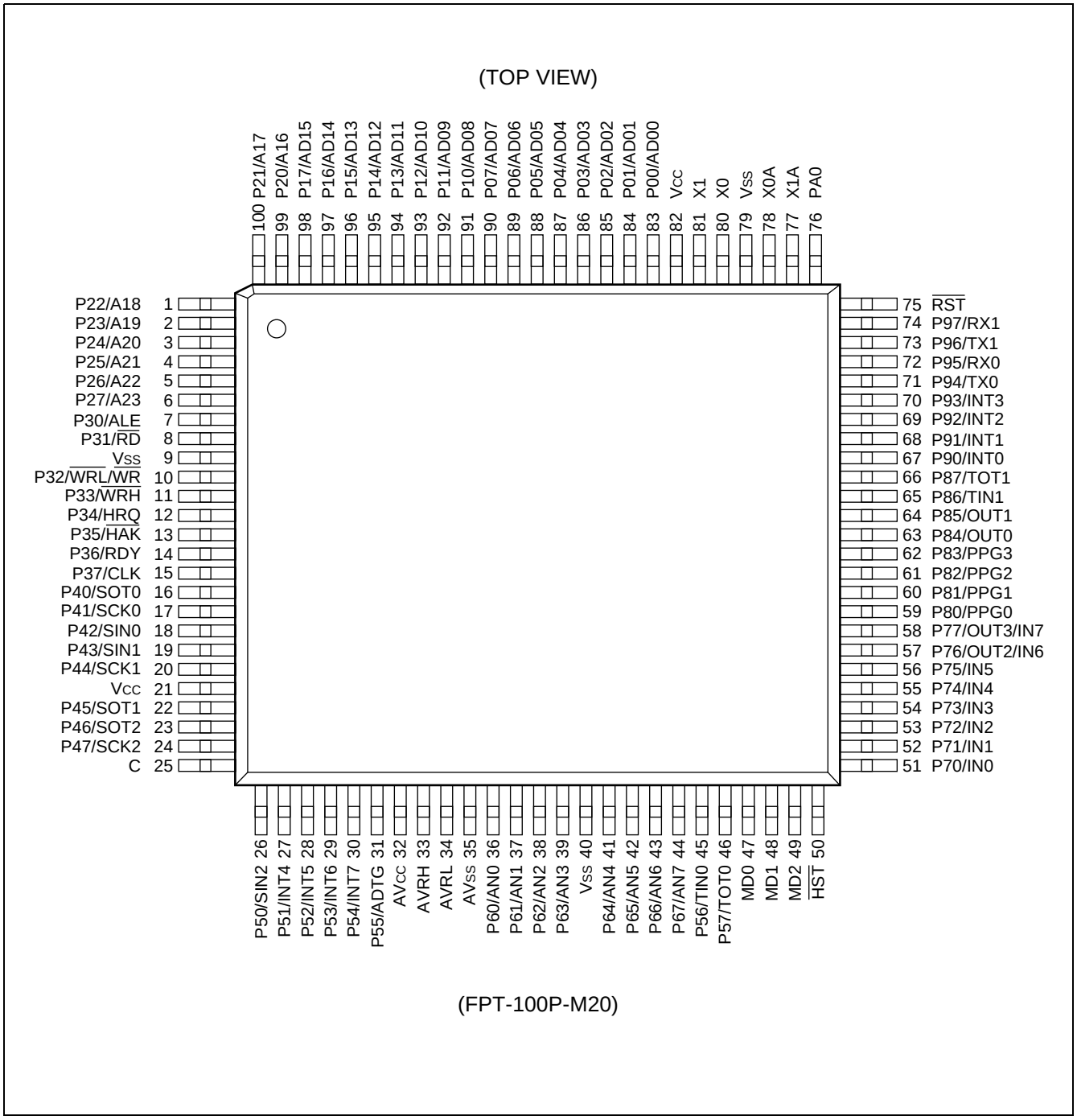
(TOP VIEW)
100 P21/A17
99 P20/A16
98 P17/AD15
97 P16/AD14
96 P15/AD13
95 P14/AD12
94 P13/AD11
93 P12/AD10
92 P11/AD09
91 P10/AD08
90 P07/AD07
89 P06/AD06
88 P05/AD05
87 P04/AD04
86 P03/AD03
85 P02/AD02
84 P01/AD01
83 P00/AD00
82 VCC
81 X1
80 X0
79 VSS
78 X0A
77 X1A
76 PA0
P22/A18 1
P23/A19 2
P24/A20 3
P25/A21 4
P26/A22 5
P27/A23 6
P30/ALE 7
P31/RD 8
VSS 9
P32/WRL/WR 10
P33/WRH 11
P34/HRQ 12
P35/HAK 13
P36/RDY 14
P37/CLK 15
P40/SOT0 16
P41/SCK0 17
P42/SIN0 18
P43/SIN1 19
P44/SCK1 20
VCC 21
P45/SOT1 22
P46/SOT2 23
P47/SCK2 24
C 25
75 RST
74 P97/RX1
73 P96/TX1
72 P95/RX0
71 P94/TX0
70 P93/INT3
69 P92/INT2
68 P91/INT1
67 P90/INT0
66 P87/TOT1
65 P86/TIN1
64 P85/OUT1
63 P84/OUT0
62 P83/PPG3
61 P82/PPG2
60 P81/PPG1
59 P80/PPG0
58 P77/OUT3/IN7
57 P76/OUT2/IN6
56 P75/IN5
55 P74/IN4
54 P73/IN3
53 P72/IN2
52 P71/IN1
51 P70/IN0
P50/SIN2 26
P51/INT4 27
P52/INT5 28
P53/INT6 29
P54/INT7 30
P55/ADTG 31
AVCC 32
AVRH 33
AVRL 34
AVSS 35
P60/AN0 36
P61/AN1 37
P62/AN2 38
P63/AN3 39
VSS 40
P64/AN4 41
P65/AN5 42
P66/AN6 43
P67/AN7 44
P56/TIN0 45
P57/TOT0 46
MD0 47
MD1 48
MD2 49
HST 50

(FPT-100P-M20)

3. Pin Description

Pin No.		Pin name	Circuit type	Function
LQFP*2	QFP*1			
80 81	82 83	X0 X1	A (Oscillation)	High speed crystal oscillator input pins
78	80	X0A	A (Oscillation)	Low speed crystal oscillator input pins. For the one clock system parts, perfom external pull-down processing.
77	79	X1A		Low speed crystal oscillator input pins. For the one clock system parts, leave it open.
75	77	$\overline{\text{RST}}$	B	External reset request input pin
50	52	$\overline{\text{HST}}$	C	Hardware standby input pin
83 to 90	85 to 92	P00 to P07	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		AD00 to AD07		I/O pins for 8 lower bits of the external address/data bus. This function is enabled when the external bus is enabled.
91 to 98	93 to 100	P10 to P17	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		AD08 to AD15		I/O pins for 8 higher bits of the external address/data bus. This function is enabled when the external bus is enabled.
99 to 6	1 to 8	P20 to P27	I	General I/O port with programmable pullup. In external bus mode, this function is valid when the corresponding bits in the external address output control resister (HACR) are set to “1”.
		A16 to A23		8-bit I/O pins for A16 to A23 at the external address/data bus. In external bus mode, this function is valid when the corresponding bits in the external address output control resister (HACR) are set to “0”.
7	9	P30	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		ALE		Address latch enable output pin. This function is enabled when the external bus is enabled.
8	10	P31	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		$\overline{\text{RD}}$		Read strobe output pin for the data bus. This function is enabled when the external bus is enabled.
10	12	P32	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode or when the $\overline{\text{WR}}$/$\overline{\text{WRL}}$ pin output is disabled.
		$\overline{\text{WRL}}$		Write strobe output pin for the data bus. This function is enabled when both the external bus and the $\overline{\text{WR}}$/$\overline{\text{WRL}}$ pin output are enabled. $\overline{\text{WRL}}$ is write-strobe output pin for the lower 8 bits of the data bus in 16-bit access. $\overline{\text{WR}}$ is write-strobe output pin for the 8 bits of the data bus in 8-bit access.
		$\overline{\text{WR}}$		

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(6) Pull-up/down resistors

The MB90540G/545G Series does not support internal pull-up/down resistors (except Port0 − Port3 : pull-up resistors) . Use external components where needed.

(7) Crystal Oscillator Circuit

Noises around X0 or X1 pins may be possible causes of abnormal operations. Make sure to provide bypass capacitors via the shortest distances from X0, X1 pins, crystal oscillator (or ceramic resonator) and ground lines, and make sure, to the utmost effort, that lines of oscillation circuits do not cross the lines of other circuits.

It is highly recommended to provide a printed circuit board artwork surrounding X0 and X1 pins with a ground area for stabilizing the operation.

(8) Turning-on Sequence of Power Supply to A/D Converter and Analog Inputs

Make sure to turn on the A/D converter power supply (AV_{CC}, AVRH, AVRL) and analog inputs (AN0 to AN7) after turning-on the digital power supply (V_{CC}) .

Turn-off the digital power after turning off the A/D converter supply and analog inputs. In this case, make sure that the voltage does not exceed AVRH or AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable) .

(9) Connection of Unused Pins of A/D Converter

Connect unused pins of A/D converter to $AV_{CC} = V_{CC}$, $AV_{SS} = AVRH = V_{SS}$.

(10) N.C. Pin

The N.C. (internally connected) pin must be opened for use.

(11) Notes on Energization

To prevent the internal regulator circuit from malfunctioning, set the voltage rise time during energization at 50 μs or more (0.2 V to 2.7 V) .

Address	Register	Abbreviation	Access	Resource name	Initial value
$A2_H$ to $A4_H$	Prohibited				
$A5_H$	Automatic ready function select register	ARSR	W	External Memory Access	0 0 1 1 _ _ 0 0_B
$A6_H$	External address output control register	HACR	W		0 0 0 0 0 0 0 0_B
$A7_H$	Bus control signal selection register	ECSR	W		0 0 0 0 0 0 0 $_B$
$A8_H$	Watchdog Timer control register	WDTC	R/W	Watchdog Timer	XXXXX 1 1 1_B
$A9_H$	Time Base Timer Control register	TBTC	R/W	Time Base Timer	1 - - 0 0 1 0 0_B
AA_H	Watch timer control register	WTC	R/W	Watch Timer	1 X 0 0 0 0 0 0_B
AB_H to AD_H	Prohibited				
AE_H	Flash memory control status register (Flash only, otherwise reserved)	FMCS	R/W	Flash Memory	0 0 0 X 0 0 0 0_B
AF_H	Prohibited				
$B0_H$	Interrupt control register 00	ICR00	R/W	Interrupt controller	0 0 0 0 0 1 1 1_B
$B1_H$	Interrupt control register 01	ICR01	R/W		0 0 0 0 0 1 1 1_B
$B2_H$	Interrupt control register 02	ICR02	R/W		0 0 0 0 0 1 1 1_B
$B3_H$	Interrupt control register 03	ICR03	R/W		0 0 0 0 0 1 1 1_B
$B4_H$	Interrupt control register 04	ICR04	R/W		0 0 0 0 0 1 1 1_B
$B5_H$	Interrupt control register 05	ICR05	R/W		0 0 0 0 0 1 1 1_B
$B6_H$	Interrupt control register 06	ICR06	R/W		0 0 0 0 0 1 1 1_B
$B7_H$	Interrupt control register 07	ICR07	R/W		0 0 0 0 0 1 1 1_B
$B8_H$	Interrupt control register 08	ICR08	R/W		0 0 0 0 0 1 1 1_B
$B9_H$	Interrupt control register 09	ICR09	R/W		0 0 0 0 0 1 1 1_B
BA_H	Interrupt control register 10	ICR10	R/W		0 0 0 0 0 1 1 1_B
BB_H	Interrupt control register 11	ICR11	R/W		0 0 0 0 0 1 1 1_B
BC_H	Interrupt control register 12	ICR12	R/W		0 0 0 0 0 1 1 1_B
BD_H	Interrupt control register 13	ICR13	R/W		0 0 0 0 0 1 1 1_B
BE_H	Interrupt control register 14	ICR14	R/W		0 0 0 0 0 1 1 1_B
BF_H	Interrupt control register 15	ICR15	R/W		0 0 0 0 0 1 1 1_B
$C0_H$ to FF_H	External				

Address	Register	Abbreviation	Access	Resource name	Initial value
$1FF0_H$	Program address detection register 0	PADR0	R/W	Address Match Detection Function	$XXXXXXXX_B$
$1FF1_H$	Program address detection register 0	PADR0	R/W		$XXXXXXXX_B$
$1FF2_H$	Program address detection register 0	PADR0	R/W		$XXXXXXXX_B$
$1FF3_H$	Program address detection register 1	PADR1	R/W		$XXXXXXXX_B$
$1FF4_H$	Program address detection register 1	PADR1	R/W		$XXXXXXXX_B$
$1FF5_H$	Program address detection register 1	PADR1	R/W		$XXXXXXXX_B$

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Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
003A88H to 003A8FH	003C88H to 003C8FH	Data register 1 (8 bytes)	DTR1	R/W	XXXXXXXXB to XXXXXXXXB
003A90H to 003A97H	003C90H to 003C97H	Data register 2 (8 bytes)	DTR2	R/W	XXXXXXXXB to XXXXXXXXB
003A98H to 003A9FH	003C98H to 003C9FH	Data register 3 (8 bytes)	DTR3	R/W	XXXXXXXXB to XXXXXXXXB
003AA0H to 003AA7H	003CA0H to 003CA7H	Data register 4 (8 bytes)	DTR4	R/W	XXXXXXXXB to XXXXXXXXB
003AA8H to 003AAFH	003CA8H to 003CAFH	Data register 5 (8 bytes)	DTR5	R/W	XXXXXXXXB to XXXXXXXXB
003AB0H to 003AB7H	003CB0H to 003CB7H	Data register 6 (8 bytes)	DTR6	R/W	XXXXXXXXB to XXXXXXXXB
003AB8H to 003ABFH	003CB8H to 003CBFH	Data register 7 (8 bytes)	DTR7	R/W	XXXXXXXXB to XXXXXXXXB
003AC0H to 003AC7H	003CC0H to 003CC7H	Data register 8 (8 bytes)	DTR8	R/W	XXXXXXXXB to XXXXXXXXB
003AC8H to 003ACFH	003CC8H to 003CCFH	Data register 9 (8 bytes)	DTR9	R/W	XXXXXXXXB to XXXXXXXXB
003AD0H to 003AD7H	003CD0H to 003CD7H	Data register 10 (8 bytes)	DTR10	R/W	XXXXXXXXB to XXXXXXXXB
003AD8H to 003ADFH	003CD8H to 003CDFH	Data register 11 (8 bytes)	DTR11	R/W	XXXXXXXXB to XXXXXXXXB
003AE0H to 003AE7H	003CE0H to 003CE7H	Data register 12 (8 bytes)	DTR12	R/W	XXXXXXXXB to XXXXXXXXB
003AE8H to 003AEFH	003CE8H to 003CEFH	Data register 13 (8 bytes)	DTR13	R/W	XXXXXXXXB to XXXXXXXXB
003AF0H to 003AF7H	003CF0H to 003CF7H	Data register 14 (8 bytes)	DTR14	R/W	XXXXXXXXB to XXXXXXXXB
003AF8H to 003AFFH	003CF8H to 003CFFH	Data register 15 (8 bytes)	DTR15	R/W	XXXXXXXXB to XXXXXXXXB

(Continued)

*1 : The interrupt request flag is cleared by the EI²OS interrupt clear signal.

*2 : The interrupt request flag is cleared by the EI²OS interrupt clear signal. A stop request is available.

Notes :

- N/A : The interrupt request flag is not cleared by the EI²OS interrupt clear signal.
- For a peripheral module with two interrupt causes for a single interrupt number, both interrupt request flags are cleared by the EI²OS interrupt clear signal.
- At the end of EI²OS, the EI²OS clear signal will be asserted for all the interrupt flags assigned to the same interrupt number. If one interrupt flag starts the EI²OS and in the meantime another interrupt flag is set by a hardware event, the later event is lost because the flag is cleared by the EI²OS clear signal caused by the first event. So it is recommended not to use the EI²OS for this interrupt number.
- If EI²OS is enabled, EI²OS is initiated when one of the two interrupt signals in the same interrupt control register (ICR) is asserted. This means that different interrupt sources share the same EI²OS Descriptor which should be unique for each interrupt source. For this reason, when one interrupt source uses the EI²OS, the other interrupt should be disabled.

11.2 Recommended Conditions

(V_{SS} = AV_{SS} = 0.0 V)

Parameter	Symbol	Value			Units	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC}, AV_{CC}	4.5	5.0	5.5	V	Under normal operation : Other than MB90F548GL(S)/543G(S)/547G(S)/548G(S)
						Under normal operation when A/D conveter is used : MB90F548GL(S)/543G(S)/547G(S)/548G(S)
		3.5	5.0	5.5	V	Under normal operation when A/D conveter is not used : MB90F548GL(S)/543G(S)/547G(S)/548G(S)
		3.0	−	5.5	V	Maintain RAM data in stop mode
Smooth capacitor	C_S	0.022	0.1	1.0	µF	*
Operating temperature	T_A	−40	−	+105	°C	

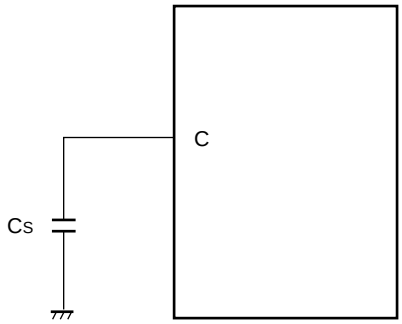
*: Use a ceramic capacitor or a capacitor of better 4. AC characteristics. The bypass capacitor should be greater than this capacitor.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

■ **C Pin Connection Diagram**



11.4.4 Power On Reset

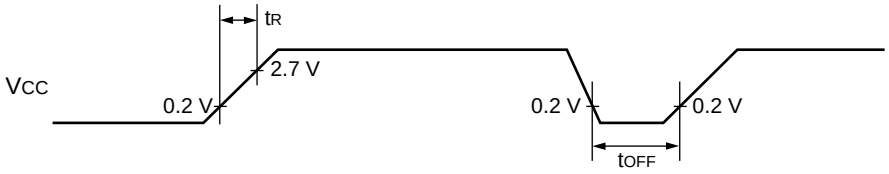
(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

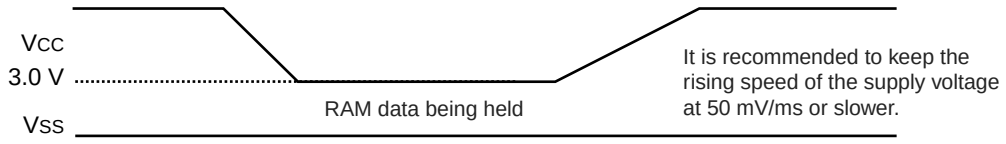
Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
Power on rise time	t_R	V_{CC}	—	0.05	30	ms	*
Power off time	t_{OFF}	V_{CC}		50	—	ms	Waiting time until power-on

* : V_{CC} must be kept lower than 0.2 V before power-on.

Notes : ■ The above values are used for creating a power-on reset.
■ Some registers in the device are initialized only upon a power-on reset. To initialize these register, turn on the power supply using the above values.



Sudden changes in the power supply voltage may cause a power-on reset.
To change the power supply voltage while the device is in operation, it is recommended to raise the voltage smoothly to suppress fluctuations as shown below.
In this case, change the supply voltage with the PLL clock not used. If the voltage drop is 1 V or fewer per second, however, you can use the PLL clock.



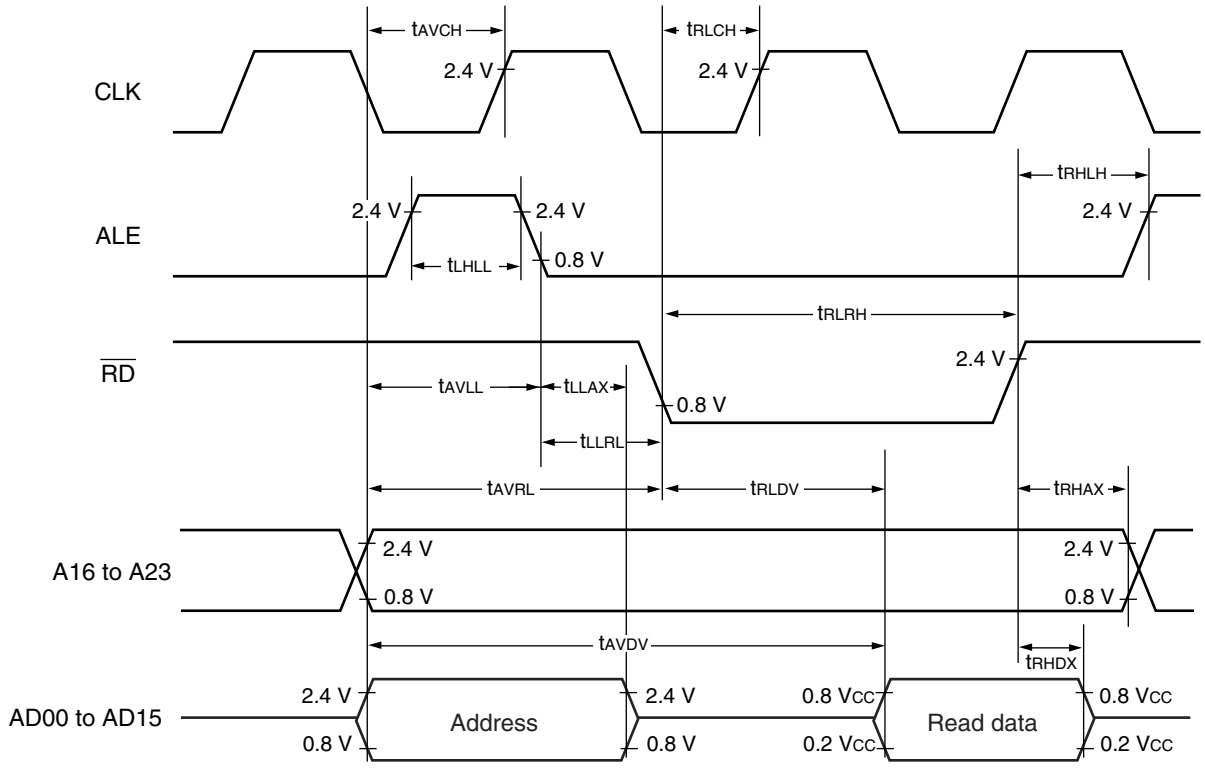
11.4.5 Bus Timing (Read)

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
ALE pulse width	t_{LHLL}	ALE		$t_{CP}/2 - 20$	−	ns	
Valid address → ALE↓ time	t_{AVLL}	ALE, A16 to A23, AD00 to AD15		$t_{CP}/2 - 20$	−	ns	
ALE↓ → Address valid time	t_{LLAX}	ALE, AD00 to AD15		$t_{CP}/2 - 15$	−	ns	
Valid address → $\overline{RD}$↓ time	t_{AVRL}	A16 toA23, AD00 to AD15, $\overline{RD}$		$t_{CP} - 15$	−	ns	
Valid address → Valid data input	t_{AVDV}	A16 to A23, AD00 to AD15		−	$5\ t_{CP}/2 - 60$	ns	
$\overline{RD}$ pulse width	t_{RLRH}	RD	−	$3\ t_{CP}/2 - 20$	−	ns	
$\overline{RD}$↓ → Valid data input	t_{RLDV}	$\overline{RD}$, AD00 to AD15		−	$3\ t_{CP}/2 - 60$	ns	
$\overline{RD}$↑ → Data hold time	t_{RHDX}	$\overline{RD}$, AD00 to AD15		0	−	ns	
$\overline{RD}$↑ → ALE↑ time	t_{RHLH}	$\overline{RD}$, ALE		$t_{CP}/2 - 15$	−	ns	
$\overline{RD}$↑ → Address valid time	t_{RHAX}	$\overline{RD}$, A16 to A23		$t_{CP}/2 - 10$	−	ns	
Valid address → CLK↑ time	t_{AVCH}	A16 to A23, AD00 to AD15, CLK		$t_{CP}/2 - 20$	−	ns	
$\overline{RD}$↓ → CLK↑ time	t_{RLCH}	$\overline{RD}$, CLK		$t_{CP}/2 - 20$	−	ns	
ALE↓ → $\overline{RD}$↓ time	t_{LLRL}	ALE, $\overline{RD}$		$t_{CP}/2 - 15$	−	ns	

■ **Bus Timing (Read)**



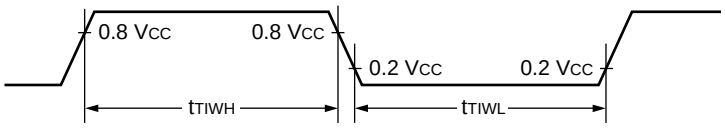
11.4.10 Timer Input Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
Input pulse width	t_{TIWH}	TIN0, TIN1	—	4 t_{CP}	—	ns	
	t_{TIWL}	IN0 to IN7					

■ **Timer Input Timing**



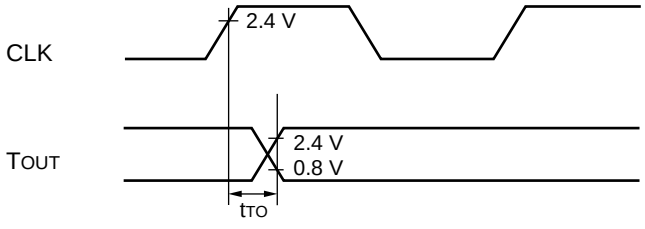
11.4.11 Timer Output Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
CLK↑ → T_{OUT} change time	t_{TO}	TOT0 , TOT1, PPG0 to PPG3	—	30	—	ns	

■ **Timer Output Timing**



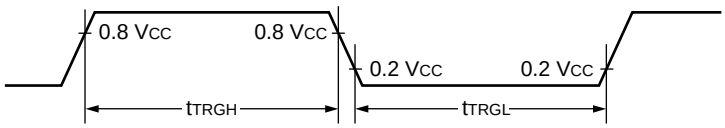
11.4.12 Trigger Input Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 3.5 V to 5.5 V, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): V_{CC} = 5.0 V ± 10%, V_{SS} = AV_{SS} = 0.0 V, T_A = − 40 °C to + 105 °C)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
Input pulse width	t_{TRGH} t_{TRGL}	INT0 to INT7, ADTG	—	5 t_{CP}	—	ns	Under nomal operation
				1	—	µs	In stop mode

■ **Trigger Input Timing**



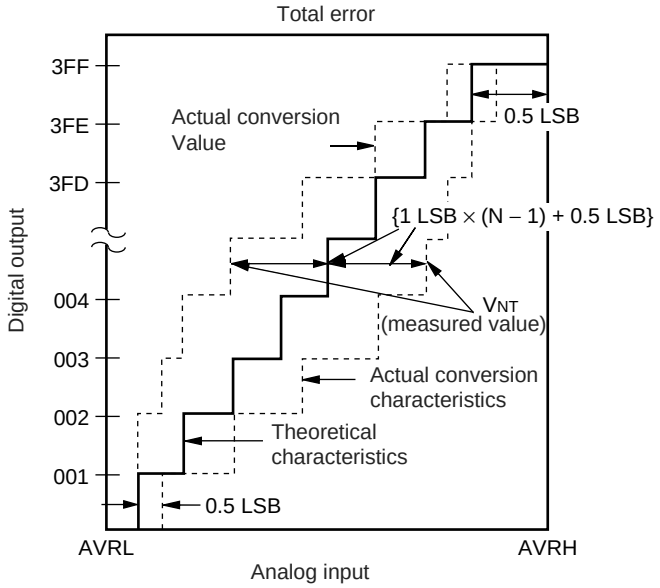
11.5.2 A/D Converter Glossary

Resolution : Analog changes that are identifiable with the A/D converter

Linearity error : The deviation of the straight line connecting the zero transition point (“00 0000 0000” ⟷ “00 0000 0001”) with the full-scale transition point (“11 1111 1110” ⟷ “11 1111 1111”) from actual conversion characteristics

Differential linearity error : The deviation of input voltage needed to change the output code by 1 LSB from the theoretical value

Total error : The total error is defined as a difference between the actual value and the theoretical value, which includes zero-transition error/full-scale transition error and linearity error.



$$1\,\text{LSB} = (\text{Theoretical value})\,\frac{\text{AVRH} - \text{AVRL}}{1024}\ [\text{V}]$$

$$V_{OT}\ (\text{Theoretical value}) = \text{AVRL} + 0.5\ \text{LSB}\ [\text{V}]$$

$$V_{FST}\ (\text{Theoretical value}) = \text{AVRH} - 1.5\ \text{LSB}\ [\text{V}]$$

$$\text{Total error for digital output N} = \frac{V_{NT} - \{1\ \text{LSB} \times (\text{N} - 1) + 0.5\ \text{LSB}\}}{1\ \text{LSB}}\ [\text{LSB}]$$

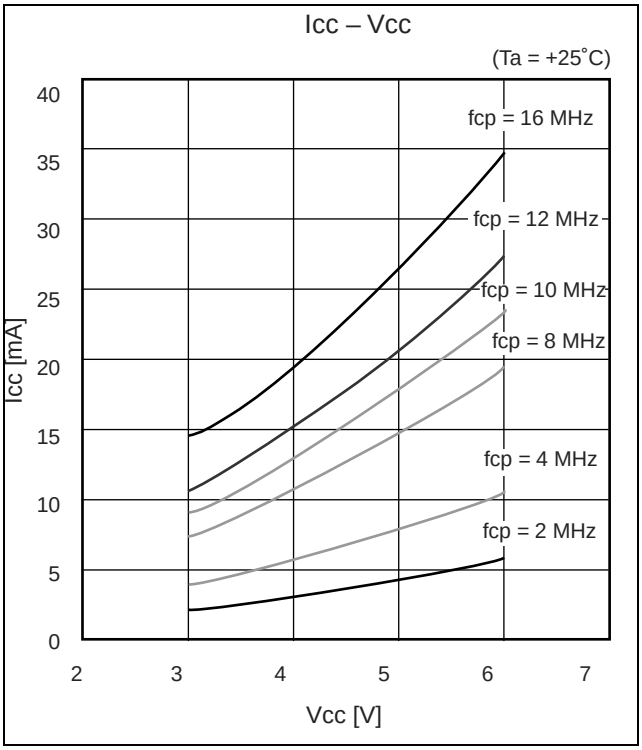
V_{NT} : Voltage at a transition of digital output from (N − 1) to N

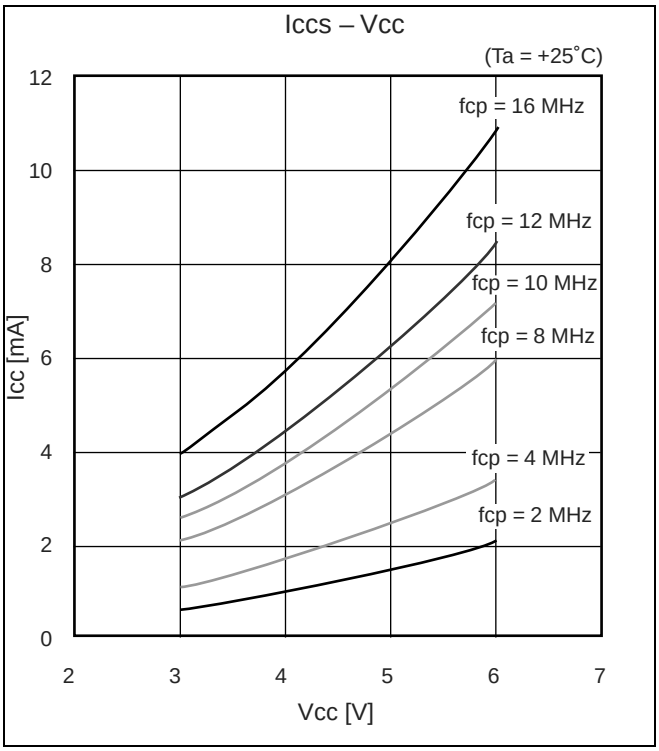
(Continued)

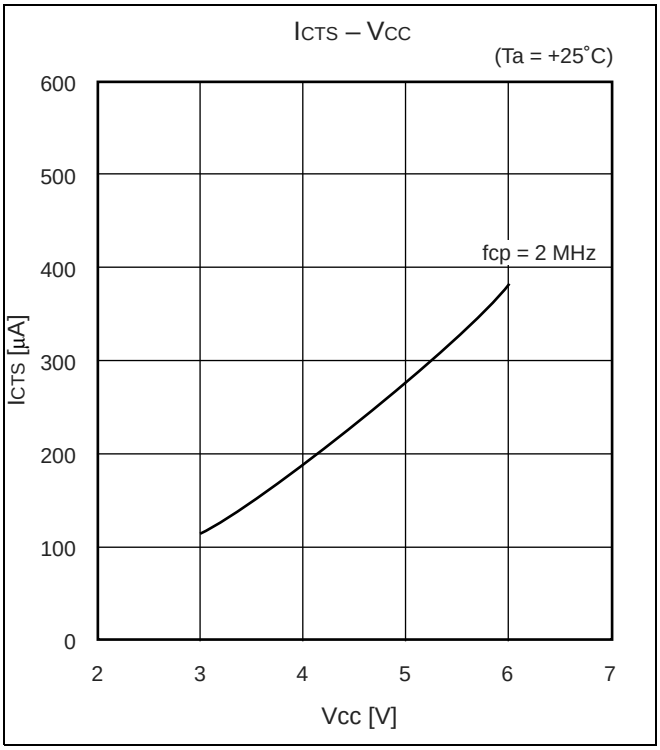
11.6 Flash Memory Program/Erase Characteristics

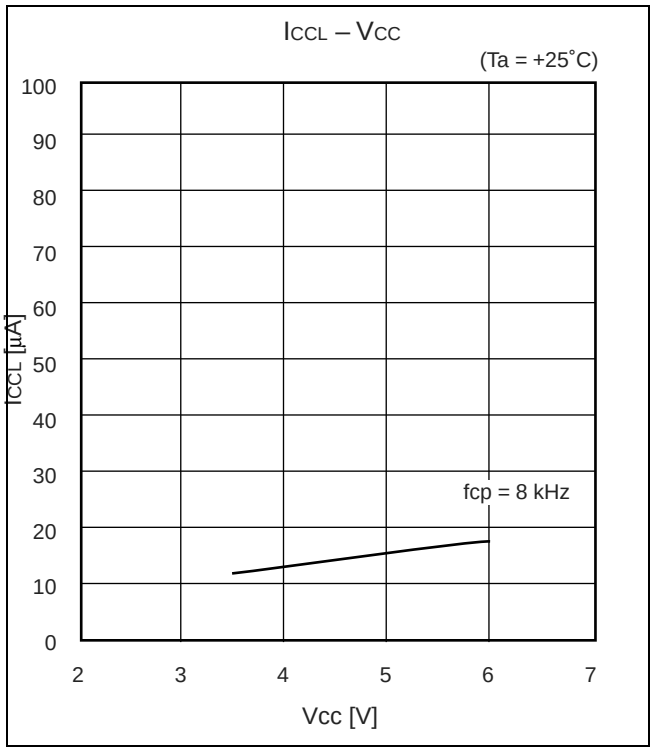
Parameter	Condition	Value			Units	Remarks	
		Min	Typ	Max			
Sector erase time	T_A = + 25 °C V_{CC} = 5.0 V	—	1	15	s	Excludes 00H programming prior erasure	
Chip erase time		—	5	—	s	MB90F543G (S) /F548G (S) /F548GL (S)	Excludes 00H programming prior erasure
			7	—	s	MB90F549G (S) /F546G (S)	
Word (16 bit width) programming time		—	16	3,600	µs	Excludes system-level overhead	
Erase/Program cycle	—	10,000	—	—	cycle		

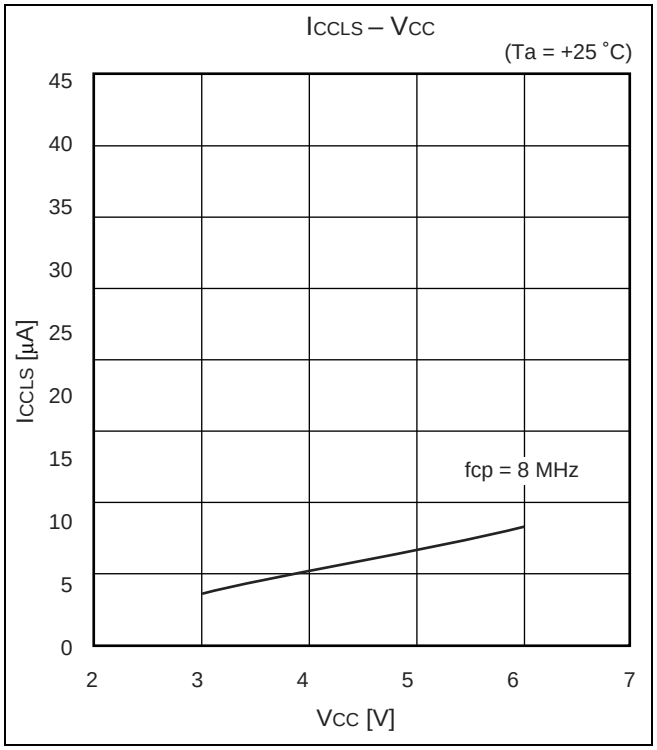
■ Power supply current (MB90549G)

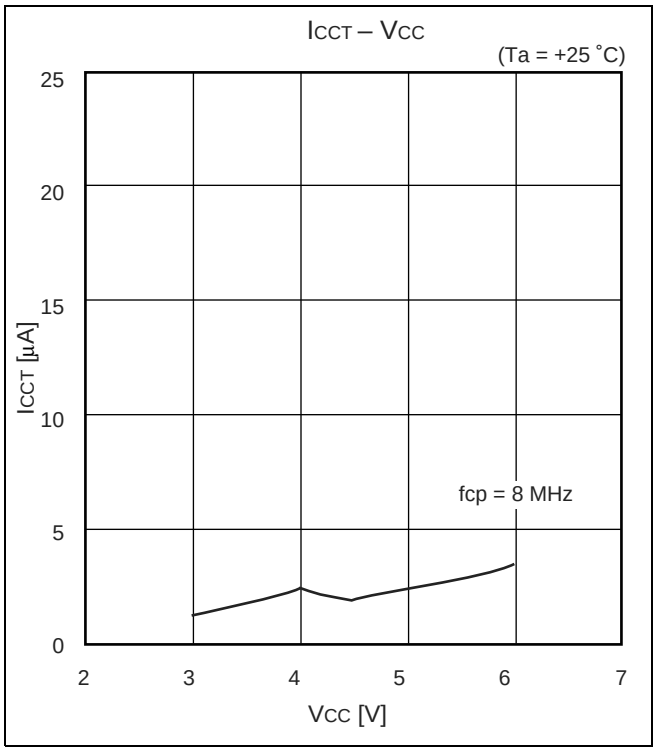


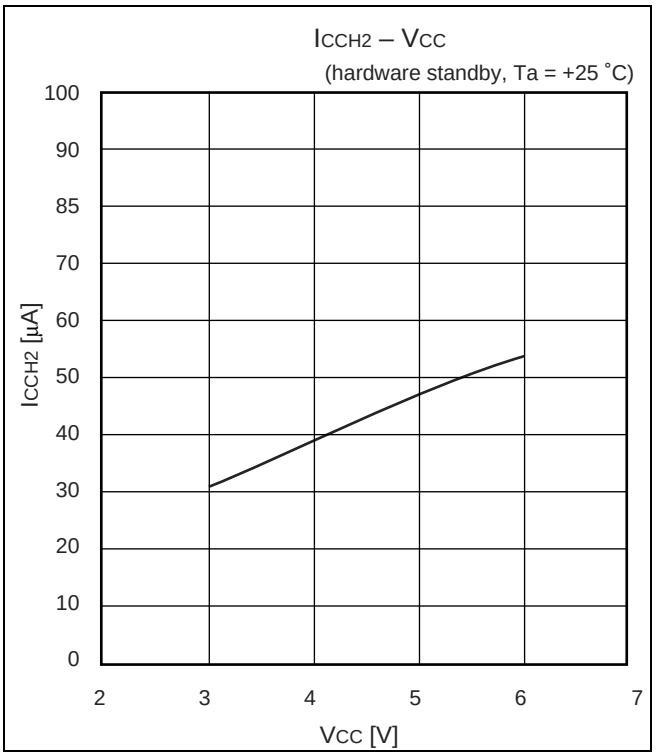


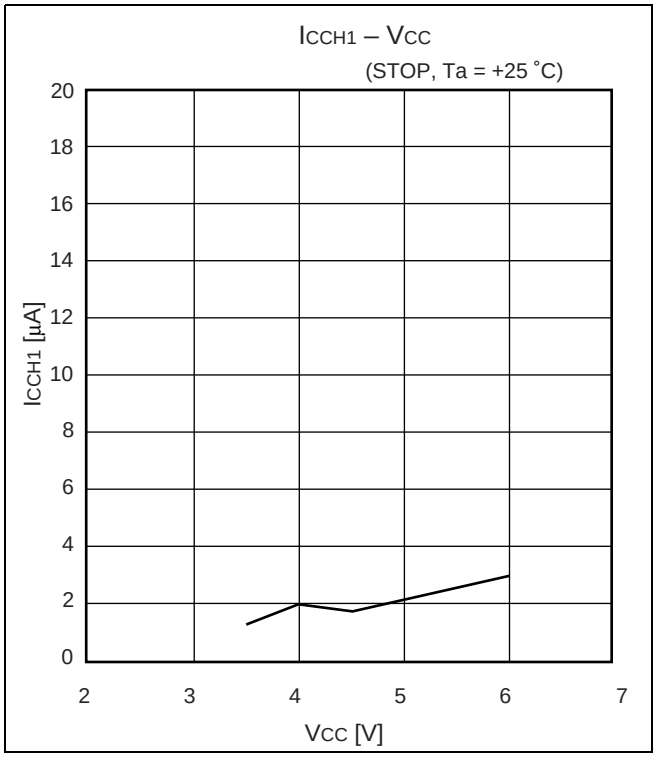





ICCLS – VCC
(Ta = +25 ˚C)
ICCLS [µA]
45
40
35
30
25
20
15
10
5
0
fcp = 8 MHz
2
3
4
5
6
7
VCC [V]


ICCT – VCC
(Ta = +25 ˚C)
ICCT [µA]
25
20
15
10
5
0
fcp = 8 MHz
2
3
4
5
6
7
VCC [V]


ICCH2 – VCC
(hardware standby, Ta = +25 ˚C)
ICCH2 [µA]
100
90
85
70
60
50
40
30
20
10
0
2
3
4
5
6
7
VCC [V]


ICCH1 – VCC
(STOP, Ta = +25 ˚C)
ICCH1 [µA]
20
18
16
14
12
10
8
6
4
2
0
2
3
4
5
6
7
VCC [V]

15. Major Changes

Spansion Publication Number: DS07-13703-7E

Section	Change Results
■ PRODUCT LINEUP	Changed the name in peripheral resource. 16-bit I/O Timer → 16-bit Free-run Timer
■ I/O CIRCUIT TYPE	Changed the name of input typ. Hysteresis → CMOS Hysteresis HYS → CMOS Hysteresis
■ BLOCK DIAGRAM	Changed the arrow direction of SOT1 signal at UART1(SCI). "← →" (input/output) → "←" (output)
■ I/O MAP	Changed the text of "Note".
■ INTERRUPT MAP	Changed the name of peripheral resource of the pin number: #19. I/O Timer → 16-bit Free-run Timer
■ ELECTRICAL CHARACTERISTICS 2. Recommended Conditions	Changed the remarks of "parameter: Power supply voltage".
3. DC Characteristics	Changed the maximum value of symbol : VILM of parameter: Input voltage. V_{CC} + 0.3 → V_{SS} + 0.3
	Added the following remarks for parameter : Pull-down resistance. Except Flash device
4. AC Characteristics (1) Clock Timing	Added the value when using an external clock in Oscillation frequency and Clock cycle time on (1) Clock Timing for parameter.
	Added the item of A/D converter operation range in figure of "■ Guaranteed PLL operation range"
(3) Reset and Hardware Standby Input Timing	Changed the following item. (3) Reset and Hardware Standby Input Timing Remarks: In sub-clock mode, sub-sleep mode, timer mode $2t_{CP}$ → $2t_{LCP}$
(4) Power On Reset	Changed as follows; Due to repetitive operation → Waiting time until power-on
5. A/D Converter	Changed the unit of Zero transition voltage and Full scale transition voltage. mV → V
■ ORDERING INFORMATION	Added the MB90F548GLPMC in Part Numbers.

NOTE: Please see "Document History" about later revised information.

Document History

Document Title: MB90F543G(S)/546G(S)/548G(S)/549G(S)/549G(S)/V540G/MB90543G(S)/547G(S)/548G(S)/F548GL(S) CMOS F2MC-16LX MB90540G/545G Series 16-bit Proprietary Microcontroller
Document Number: 002-07696

Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	—	AKIH	11/13/2008	Migrated to Cypress and assigned document number 002-07696. No change to document contents or format.
*A	5537115	AKIH	11/30/2016	Updated to Cypress template